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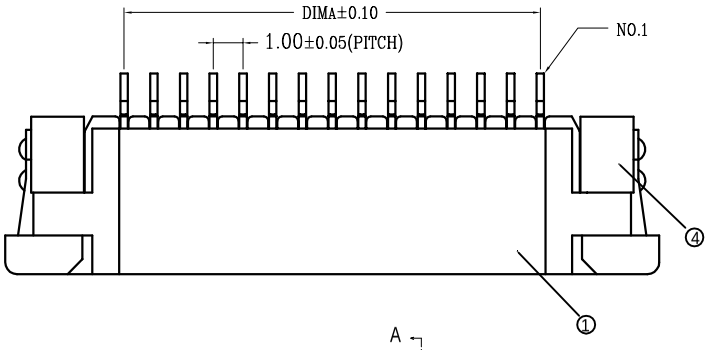
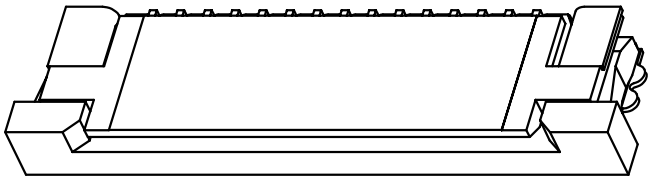
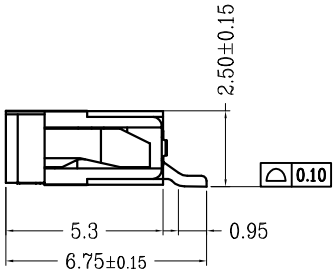
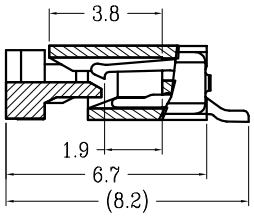
技术指标(Technical Index):

1.塑件表面应光洁、无毛边、无明显收缩、 缺陷、裂纹等现象.
(The surface of the plastic parts should be smooth,no rough edges,no obvious shrinkage,defects,cracks and other phenomena.)
2.温度范围(Temperature range): -25° C～+85° C.
3.额定电压(Rated voltage): 50V, AC/DC(=等效).
4.接触电阻(Contact resistance): ≤0.03Ω.
5.绝缘电阻(Insulation resistance):≥500MΩ.

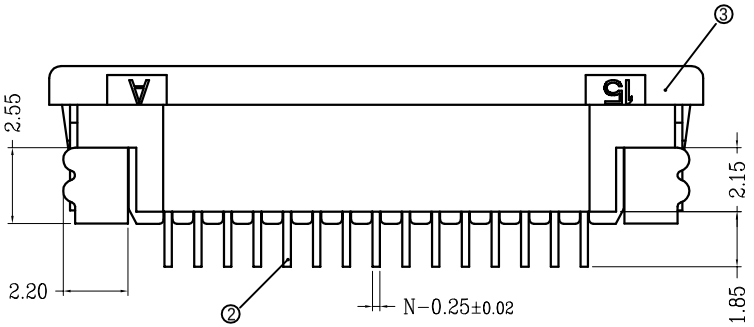


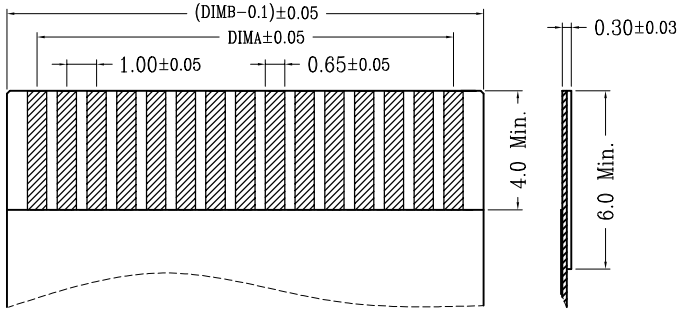






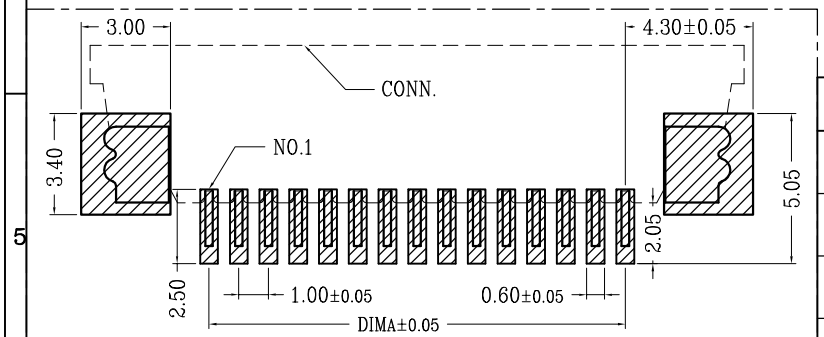
SECTION A-A





适用扁平线(Applicable Flat Cable)

CKT	DIM A	DIM B	DIM C
4	3.00	5.03	11.10
5	4.00	6.03	12.10
6	5.00	7.03	13.10
7	6.00	8.03	14.10
8	7.00	9.03	15.10
9	8.00	10.03	16.10
10	9.00	11.03	17.10
11	10.00	12.03	18.10
12	11.00	13.03	19.10
13	12.00	14.03	20.10
14	13.00	15.03	21.10
15	14.00	16.03	22.10
16	15.00	17.03	23.10
17	16.00	18.03	24.10
18	17.00	19.03	25.10
19	18.00	20.03	26.10
20	19.00	21.03	27.10
21	20.00	22.03	28.10
22	21.00	23.03	29.10
23	22.00	24.03	30.10
24	23.00	25.03	31.10
25	24.00	26.03	32.10
26	25.00	27.03	33.10
27	26.00	28.03	34.10
28	27.00	29.03	35.10
29	28.00	30.03	36.10
30	29.00	31.03	37.10
31	30.00	32.03	38.10
32	31.00	33.03	39.10
33	32.00	34.03	40.10
34	33.00	35.03	41.10
35	34.00	36.03	42.10
36	35.00	37.03	43.10
37	36.00	38.03	44.10
38	37.00	39.03	45.10
39	38.00	40.03	46.10
40	39.00	41.03	47.10



适用线路板(PCB LAYOUT)

序号	品名	材质
①	1.0K型胶芯(H2.5) 1.0K Type Housing (H2.5)	LCP UL94V-0 本色 **Natural**
②	1.0K型上接端子(H2.5) 1.0K Type Upper Terminal(H2.5)	铜合金/表面镀锡 Copper Alloy/ Tin Plating
③	1.0K型卧式后盖(H2.5) 1.0K Type Actuator (H2.5)	LCP UL94V-0 黑色 **Black**
④	1.0K型卧式焊片(H2.5) 1.0K Type Fitting Nail(H2.5)	铜合金/表面镀锡 Copper Alloy/ Tin Plating

深圳市万骏达电子有限公司 http://www.wanjunda.com		图号(DWG NO)	单位(UNIT): MM
		版本(REV)	比例(SCALE)1:1
		日期(DATE)	
品名(ITEM NO)	1.0 Pitch K型卧式上接(H=2.5) 1.0 Pitch H2.5 ZIF R/A Type Top CONN.	设计(DESIGN)	未注公差 TOLERANCE UNSPECIFIED
料号(PART NO)	FPC-1.0-nP-2.5H-S	审核(CHECKED)	X.X ±0.30 X.XX ±0.20 X.XXX ±0.10 X° ±5° X.X° ±2°
模号(MODEL NO)		核准(APPROVED)	

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